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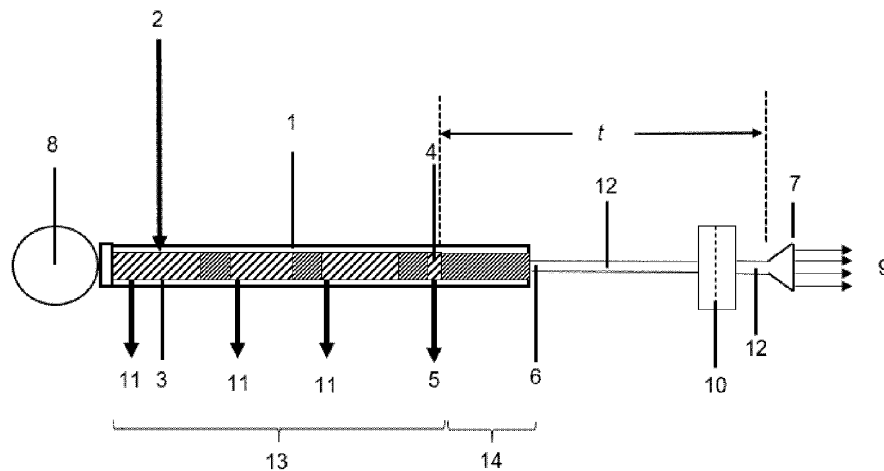


Figure 1

(57) Abstract: The present invention relates to a process for the manufacturing an acrylic copolymer having increased heat resistance, high transparency and improved adhesion to metal surfaces. The invention further relates to moulding compositions comprising this copolymer. The moulding compositions of the present invention are highly suitable for the manufacturing of optical elements for optoelectronic devices comprising acrylic and metallic or ceramic parts.

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